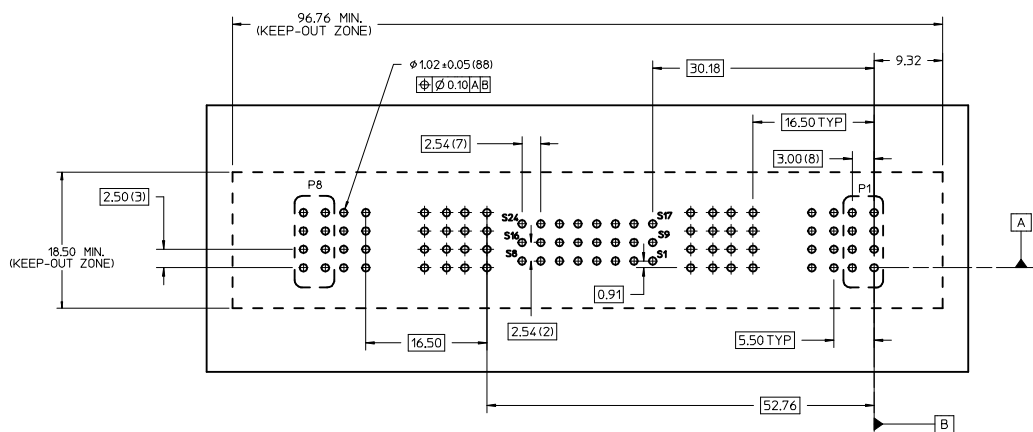
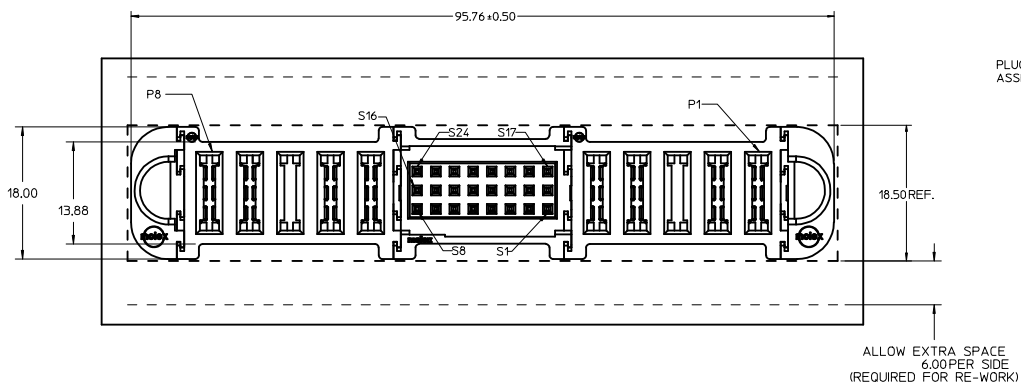
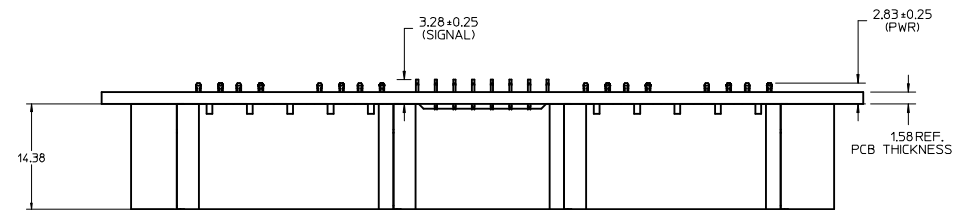
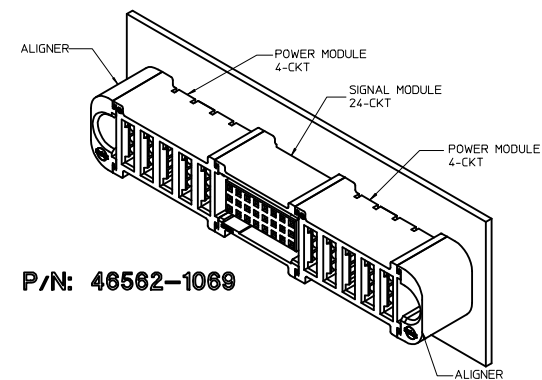
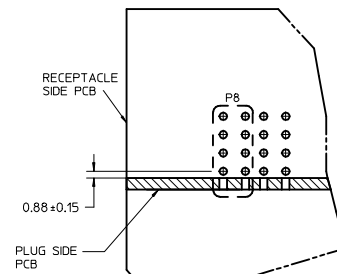
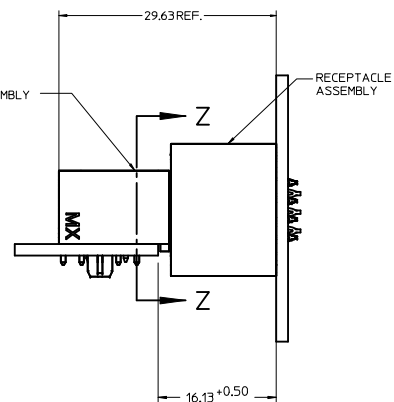




RECOMMENDED PCB LAYOUT AND KEEP-OUT ZONE



P/N: 46562-1069



PARTIAL SECTION Z-Z
SCALE 3:1

NOTES:

1. MATERIAL:
-HOUSINGS: LCP UL94 V-0, COLOR: BLACK.
-TERMINALS: COPPER ALLOY.
-PLATING: 0.000127/0.00050 NICKEL OVERALL WITH 0.00254/0.00100 SELECTIVE TIN ON COMPLIANT PINS.
AND 0.000762/0.00030 SELECTIVE GOLD ON CONTACT AREA.
2. PACKAGING ASSEMBLIES TO BE TRAY PACKED PER PACKAGING SPEC PK-46562-XXX.
3. PRODUCT SPEC: PS-46436-100.
4. APPLICATION SPEC: AS-46436-100.
5. PRODUCT TO MEET ROHS REQUIREMENTS.
6. ASSEMBLY MATES WITH PLUG ASSEMBLY, P/N 46437-1069.

PRELIMINARY IEC NO: UCP2009-2085 DRAWN BY: BKOSTIC CHYK: 2009/03/04 APPR: APATEL 2009/03/10	QUALITY SYMBOLS	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE		SCALE	DESIGN UNITS	 THIRD ANGLE PROJECTION	
							MM ONLY		3:1	METRIC		
			mm		INCH		DRAWN BY	DATE	TITLE			
			4 PLACES ±	---	±	---	BKOSTIC	2008/08/07	VERT. REIPT ASSY			
			3 PLACES ±	---	±	.010	CHECKED BY	DATE	4P-24S-4P			
			2 PLACES ±	0.25	±	.010	BKOSTIC	2008/05/16	TEN60 POWER FAMILY			
			1 PLACE ±	0.25	±	---	APPROVED BY	DATE				
			ANGULAR ±1/2°				APATEL		 MOLEX INCORPORATED			
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				MATERIAL NO.		DOCUMENT NO.			SHEET NO.
							46562-1069		SD-46562-169			1 OF 1
SIZE:  THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												